

## **Intergroup Assembly Scholarship Application Form**

Intergroup Name	Inter	group Number:
Street or P.O.Box Address		
City	State	Zip Code
Telephone	Email address	
Intergroup Contact: Contact Phone #:	Contact Email add	dress
Applications may be al	so be emailed to: treasurer@	<u> </u>
Applications may be al	so be emailed to, treasurer	⊉oar2.org
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(See reverse for Scholarship Policy)

## Per R2 Policy & Procedure Manual, Section VIII, Item D:

## 4. INTERGROUP ASSEMBLY SCHOLARSHIP FUND

- a) The Intergroup Outreach Committee will, with the assistance of the R2 Board Liaison:
  - i. Determine initial Intergroup eligibility for funds, based on information provided by the R2 Board.
  - ii. Coordinate participation, including:
    - a. Contacting intergroups eligible to participate.
    - b. Distributing application forms, when requested.
    - c. Reminding intergroups they must submit completed application forms to the R2 board a minimum of 45 days prior to the assembly, for final determination. If funds are available, the deadline will be extended.
- b) Intergroup Assembly Scholarship Funds shall be available to assist up to three (3) Intergroups with financial hardships. Preference is given to those intergroups that have not participated in the last two (2) assemblies.
- c) Funding shall be as follows:
  - i. Individuals will be given a stipend for transportation and meal allowances upon arrival.
  - ii. Hotel accommodations are predicated on room sharing, whenever possible, and will be paid directly by R2.
  - iii. One Day Assemblies: Payment for one night at the hotel, \$30.00 for transportation, and \$30.00 for meals.
- iv. Two Day Assemblies: Payment for two nights at the hotel, \$30.00 for transportation, and \$50.00 for meals.
- d) Participants are expected to attend all business meetings.
- e) Assembly preregistration fee is the responsibility of the intergroup.
- f) Intergroups receiving this scholarship are not eligible for IFAP funding.
- g) Distribution of available scholarship funds will be determined by the R2 Board.